# STWA70N60DM2



## N-channel 600 V, 0.037 Ω typ., 66 A MDmesh<sup>™</sup> DM2 Power MOSFET in a TO-247 long leads package

Datasheet - production data

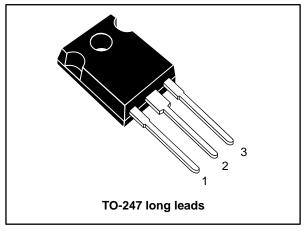
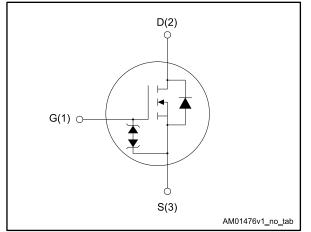


Figure 1: Internal schematic diagram



### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ID	Ртот
STWA70N60DM2	600 V	0.042 Ω	66 A	446 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

### **Applications**

Switching applications

### Description

This high voltage N-channel Power MOSFET is part of the MDmesh<sup>TM</sup> DM2 fast recovery diode series. It offers very low recovery charge ( $Q_{rr}$ ) and time ( $t_{rr}$ ) combined with low  $R_{DS(on)}$ , rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STWA70N60DM2	70N60DM2	TO-247 long leads	Tube

DocID027892 Rev 2

This is information on a product in full production.

### Contents

## Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	TO-247 long leads package information	9
5	Revisio	n history	11



## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	±25	V
	Drain current (continuous) at T <sub>case</sub> = 25 °C	66	٨
ID	Drain current (continuous) at T <sub>case</sub> = 100 °C	42	A
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	264	А
P <sub>TOT</sub>	Total dissipation at T <sub>case</sub> = 25 °C	446	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	50	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	v/ns
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature	-55 10 150	C

#### Notes:

 $^{\left( 1\right) }$  Pulse width is limited by safe operating area.

 $^{(2)}$  I\_{SD}  $\leq 66$  A, di/dt=900 A/µs; V\_{DS} peak < V\_(BR)DSS, V\_DD = 400 V.

<sup>(3)</sup>  $V_{DS} \le 480 \text{ V}.$ 

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.28	9 <b>0</b> AA/
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	50	°C/W

#### Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (Pulse width limited by $T_{jmax}$ )	10	А
E <sub>AR</sub>	Single pulse avalanche energy (starting $T_j$ = 25 °C, $I_D$ = $I_{AR}$ , $V_{DD}$ = 50 V)	1500	mJ



## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5: Static						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, \text{ I}_D = 1 \text{ mA}$	600			V
		$V_{GS} = 0 \text{ V}, \text{ V}_{DS} = 600 \text{ V}$			10	
I <sub>DSS</sub>	I <sub>DSS</sub> Zero gate voltage drain current	$V_{GS} = 0 \text{ V},  V_{DS} = 600 \text{ V},$ $T_{case} = 125 ^{\circ}\text{C}$			100	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±25 V			±5	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}=V_{GS},I_{D}=250\;\mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 33 \text{ A}$		0.037	0.042	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	5508	-	
C <sub>oss</sub>	Output capacitance	$V_{DS} = 100 \text{ V}, \text{ f} = 1 \text{ MHz},$ $I_D = 0 \text{ A}$	-	241	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	2.8	-	
Coss (1) eq.	Equivalent output capacitance	$V_{DS}$ = 0 to 480 V, $V_{GS}$ = 0 V	-	470	-	рF
R <sub>G</sub>	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	2	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 66 A,	-	121	-	
Q <sub>gs</sub>	Gate-source charge	$V_{GS}$ = 10 V (see <i>Figure 15:</i>	-	26	-	nC
$Q_gd$	Gate-drain charge	"Gate charge test circuit")	-	61	-	

#### Table 6: Dynamic

#### Notes:

 $^{(1)}$   $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 7	: Switchin	a times
1 4 6 10 1		9

		_				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 33 A	-	32	-	
tr	Rise time	$V_{DD} = 300 \text{ V}, \text{ ID} = 33 \text{ A}$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V} \text{ (see}$		67	-	
t <sub>d(off)</sub>	Turn-off delay time	Figure 14: "Switching times test	-	112	-	ns
t <sub>f</sub>	Fall time	circuit for resistive load" and )	-	10.4	-	



#### STWA70N60DM2

#### Electrical characteristics

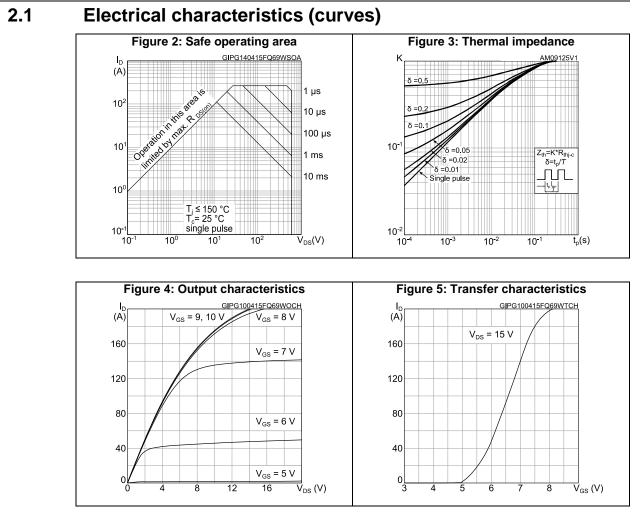
Table 8: Source-drain diode							
Symbol	bol Parameter Test conditions I		Min.	Тур.	Max.	Unit	
I <sub>SD</sub>	Source-drain current		-		66	А	
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		264	А	
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 66 A$	-		1.6	V	
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 66 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	150		ns	
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit for inductive load	-	0.75		μC	
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	10.5		A	
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 66 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	250		ns	
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 16: "Test circuit for	-	2.5		μC	
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	20.7		A	

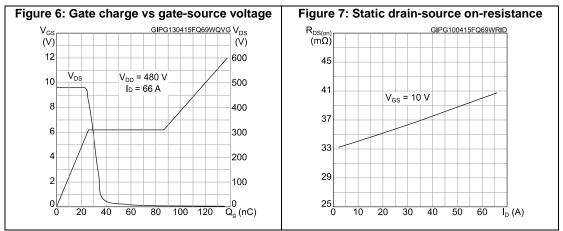
#### Notes:

 $^{\left(1\right)}$  Pulse width is limited by safe operating area.

<sup>(2)</sup> Pulse test: pulse duration = 300  $\mu$ s, duty cycle 1.5%.

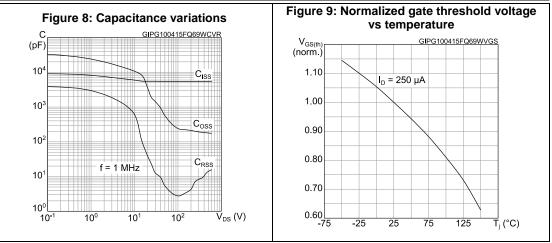


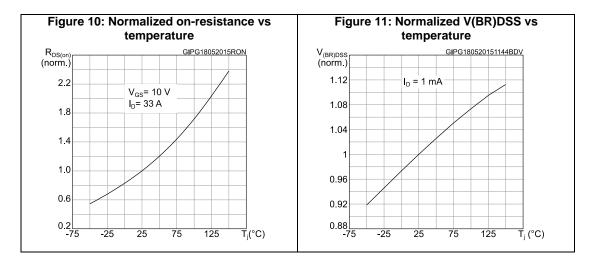


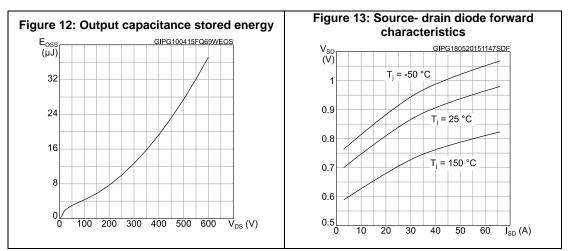




#### **Electrical characteristics**



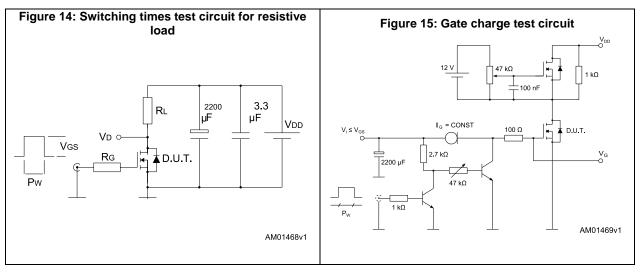


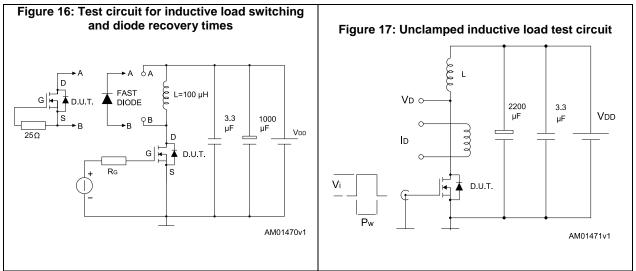


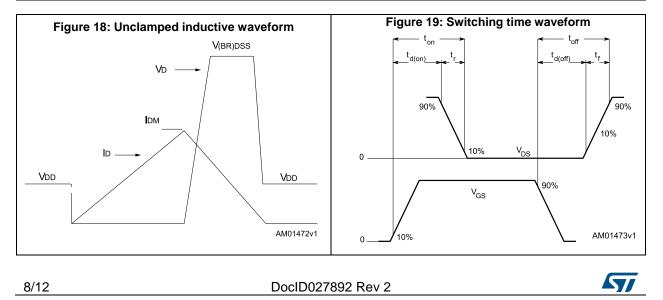
57

DocID027892 Rev 2

### 3 Test circuits







### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 4.1 TO-247 long leads package information

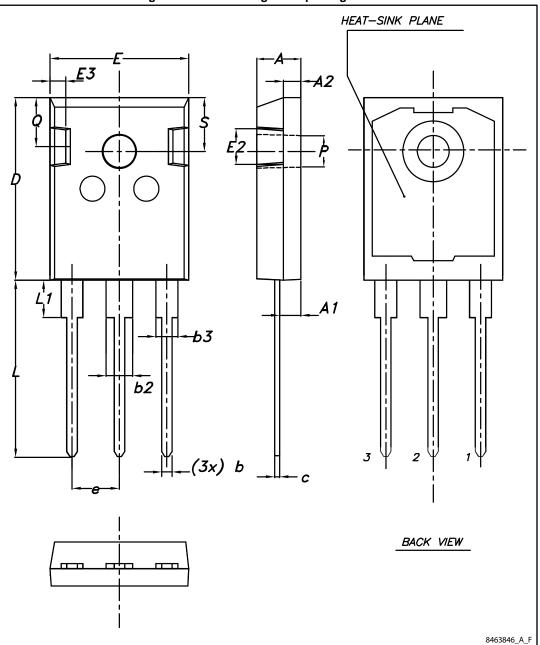


Figure 20: TO-247 long leads package outline



DocID027892 Rev 2

#### Package information

#### STWA70N60DM2

Table 9: TO-247 long leads package mechanical data					
Dim		mm.			
Dim.	Min.	Тур.	Max.		
А	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.26		
b2			3.25		
b3			2.25		
С	0.59		0.66		
D	20.90	21.00	21.10		
E	15.70	15.80	15.90		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	5.34	5.44	5.54		
L	19.80	19.92	20.10		
L1			4.30		
Р	3.50	3.60	3.70		
Q	5.60		6.00		
S	6.05	6.15	6.25		

10/12 DocID027892 Rev 2



## 5 Revision history

Date	Revision	Changes
19-May-2015	1	First release.
08-Jul-2015	2	Text and formatting changes throughout document Datasheet promoted from preliminary data to production data In Section <i>Electrical characteristics</i> : - updated Table <i>Dynamic</i> and <i>Source-drain diode</i>



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